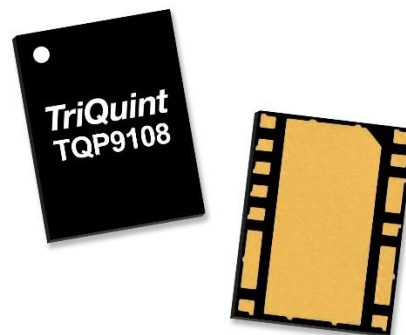
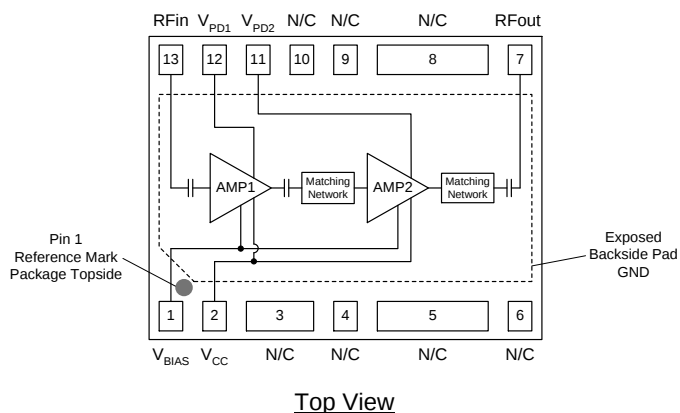


General Description

The TQP9108 is a high-efficiency two-stage power amplifier in a low-cost surface-mount package. The amplifier is able to achieve 39% power added efficiency at +27 dBm output power while operating with a low 65 mA idle current. The amplifier is designed to ensure that all odd-order IMD products are below -17 dBm at all output power levels below +24 dBm/ton.

The TQP9108 integrates two high performance amplifier stages onto a module to allow for a compact system design and requires very few external components for operation. The amplifier is bias adjustable allowing the amplifier's power consumption to be optimized. The TQP9108 is available in a lead-free/RoHS-compliant 13-pin 3.5 x 4.5mm surface mount package and is pin-compatible to the higher frequency band version in the family with the TQP9107 (699-960 MHz).

Functional Block Diagram



3.5 x 4.5 mm Leadless SMT Package

Product Features

- 1.71 – 2.17 GHz Frequency Range
- 30.5 dB gain
- +46 dBm Output IP3 at P_{out} = +24 dBm/ton
- 39% PAE at +27 dBm P_{out}
- Internally Matched
- Integrated Inter-Stage Matching
- Bias Adjustable
- Low idle current

Applications

- Wireless Infrastructure
- Repeaters, Boosters, DAS
- High Power Amplifiers
- Small cell BTS

Ordering Information

Part No.	Description
TQP9108	1.71 – 2.17 GHz Power Amplifier
TQP9108-PCB	Evaluation Board

Absolute Maximum Ratings

Parameter	Rating
Storage Temperature	-55 to +150 °C
RF Input Power, CW, 50 Ω, T=25 °C	+12 dBm
Supply Voltage (V _{CC})	+6 V

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability.

Recommended Operating Conditions

Parameter	Min	Typ	Max	Units
V _{CC}		+4.3	+5.0	V
V _{BIAS}		+4.0	V _{CC}	V
V _{PD1} , V _{PD2}		+4.0	V _{CC}	V
T _{CASE}	-40		+105	°C
T _j for >10 ⁶ hours MTTF			+170	°C

Electrical specifications are measured at specified test conditions. Specifications are not guaranteed over all recommended operating conditions.

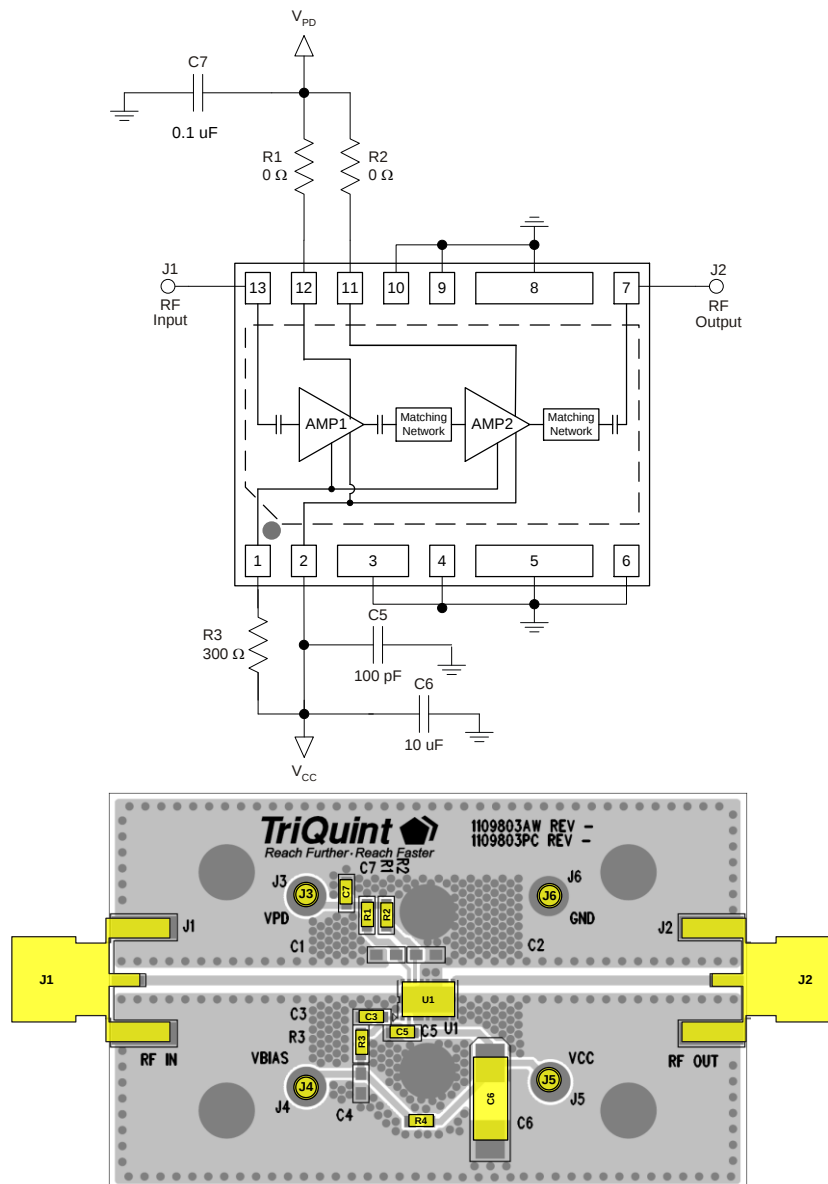
Electrical Specifications

Parameter	Conditions ⁽¹⁾	Min	Typ	Max	Units
Operational Frequency Range		1710		2170	MHz
Test Frequency			1915		MHz
Gain		28.8	30.5		dB
Noise Figure			5		dB
Output P1dB			+31.3		dBm
Output IP3	P _{out} = +23 dBm/tone, Δf = 600 kHz	+41	+46		dBm
IMD3, IMD5, IMD7	All power levels ≤ 23 dBm / tone			-17	dBm
Current, I _{CC}	P _{out} = +27 dBm		300		mA
Power Added Efficiency	P _{out} = +27 dBm		39		%
Idle Current	No RF Input Power		67		mA
VSWR Survivability	P _{out} = P1dB, Signal: CW, All Phases	10:1			–
	P _{out} = +28 dBm, All Phases Signal: 20 MHz LTE 1C, PAR = 9.5 dB	6:1			–
Thermal Resistance, θ _{Jc}	Junction to case		37.5		°C/W

Notes:

1. Test conditions unless otherwise noted: V_{CC} = +4.3 V, V_{PD1} = V_{PD2} = +4.0 V, Temp = +25 °C, 50 Ω system.

Application Circuit Schematic and Layout – TQP9108-PCB



Bill of Material – TQP9108-PCB

Reference Des.	Value	Description	Manuf.	Part Number
n/a		PCB, Nelco FR4, APP BOARD	Qorvo	1109803PC
U1		AMP, 2-Stage Power Amplifier	Qorvo	TQP9108
C5	100 pF	CAP, 0603, 5%, 50V, NPO	various	
C6	10 μ F	CAP, 6032, 20%, 50V, Tantalum	various	
C7	0.1 μ F	CAP, 0603, 50V, X7R, 5%	various	
R1, R2, R4	0 Ω	RES, 0603, 5%, 1/16W, Chip	various	
R3	300 Ω	RES, 0603, 5%, 1/16W, Chip	various	

Typical Performance – TQP9108-PCB

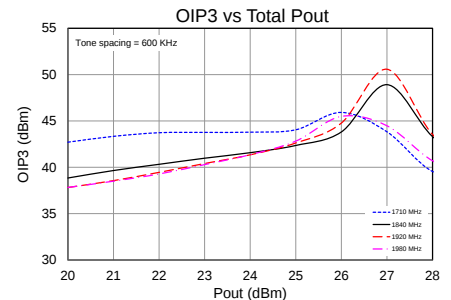
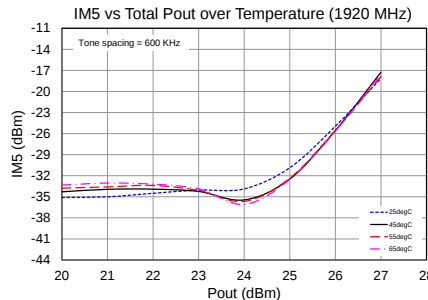
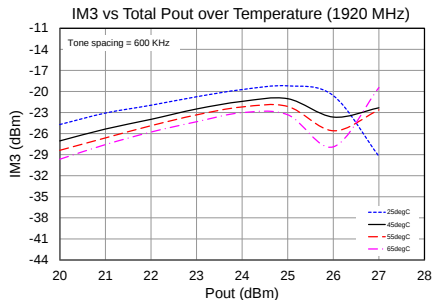
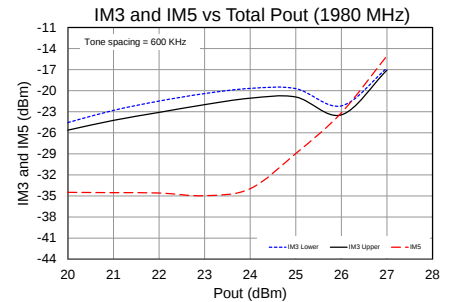
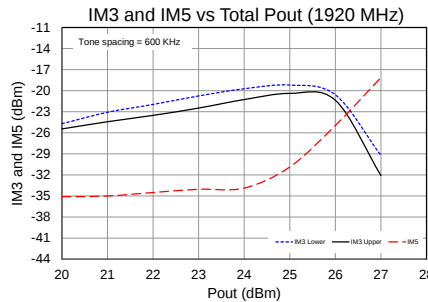
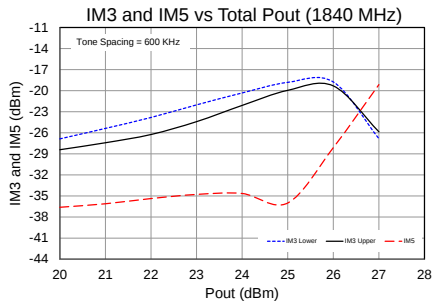
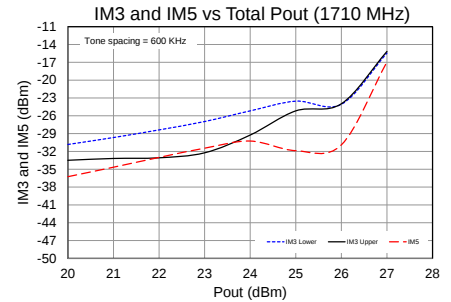
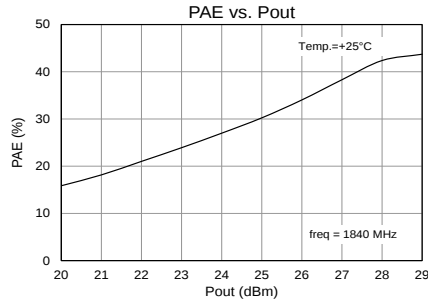
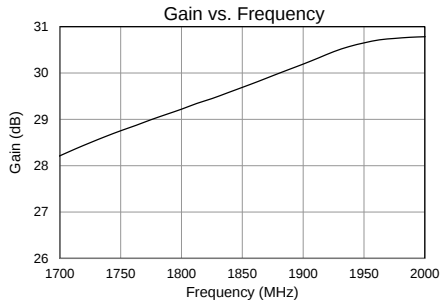
Parameter	Conditions ⁽¹⁾	Typical Value				Units
Frequency		1710	1840	1920	1980	MHz
Gain		28.4	29.6	30.4	30.7	dB
IM3	Pout= +27 dBm, Δf = 600 KHz	-15.5	-26	-29	-17	dBm
IM5	Pout= +27 dBm, Δf = 600 KHz	-17	-19	-18	-15.5	dBm
Quiescent Collector Current, I _{CQ}	V _{PD} = +4 V	67				mA

Notes:

1. Test conditions unless otherwise noted: V_{CC} = +4.3V, V_{PD1} = V_{PD2} = +4.0V, Temp.=+25 °C

Performance Plots – TQP9108-PCB

Test conditions unless otherwise noted: V_{CC} = +4.3V, V_{PD1} = V_{PD2} = +4.0V, Temp.=+25 °C



Typical Performance – $V_{CC} = +5.0\text{ V}$

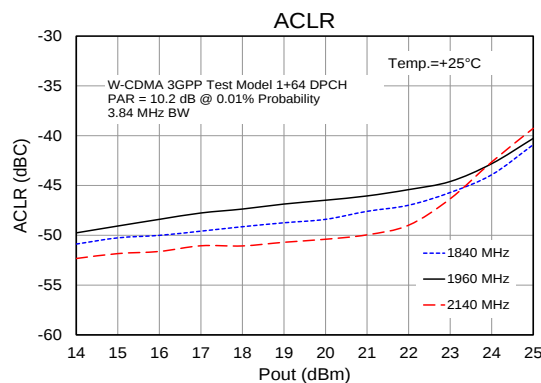
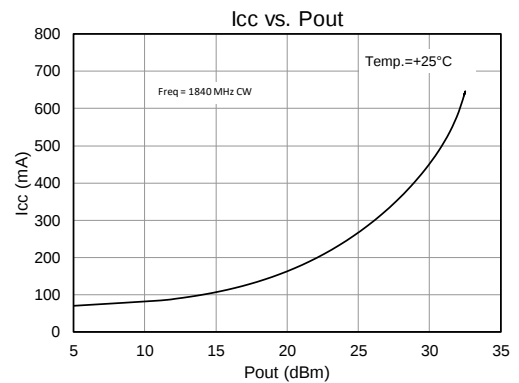
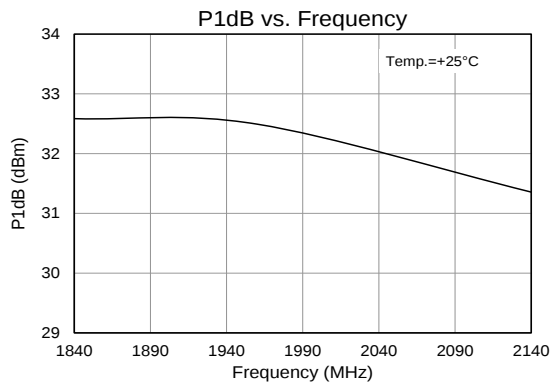
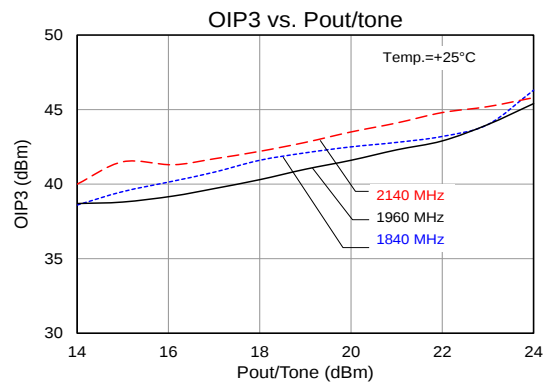
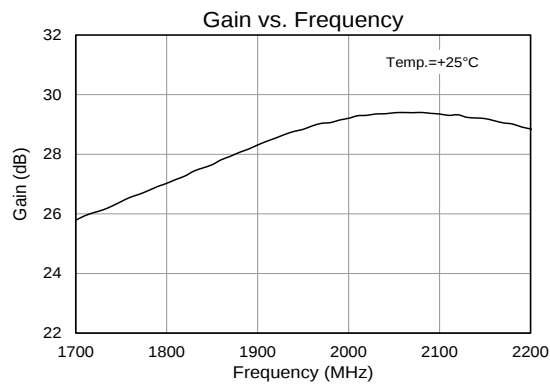
Parameter	Conditions ⁽¹⁾	Typical Value			Units
Frequency		1840	1960	2140	MHz
Gain		28	28.5	29.4	dB
Input Return Loss		-12	-11	-9	dB
Output P1dB		+32.6	+32.5	+31.4	dBm
Output IP3	Pout = +24 dBm, $\Delta f = 1\text{ MHz}$	+46.2	+45.4	+45.7	dBm
Quiescent Collector Current, I_{CQ}	$V_{PD} = +4.3\text{ V}$	84			mA

Notes:

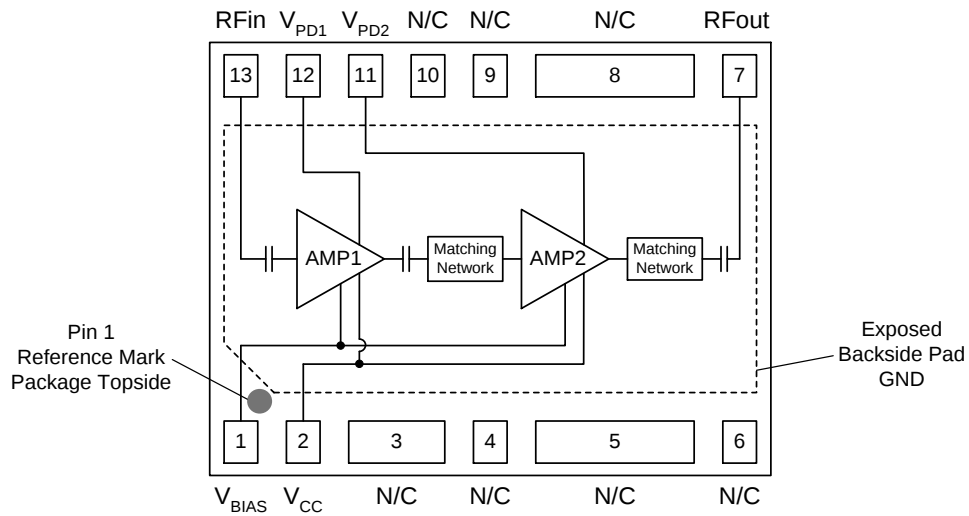
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Performance Plots – $V_{CC} = +5.0\text{ V}$

Test conditions unless otherwise noted: $V_{CC} = +5.0\text{ V}$, $V_{PD1} = V_{PD2} = +4.3\text{ V}$, Temp. = +25 °C



Pin Configuration and Description

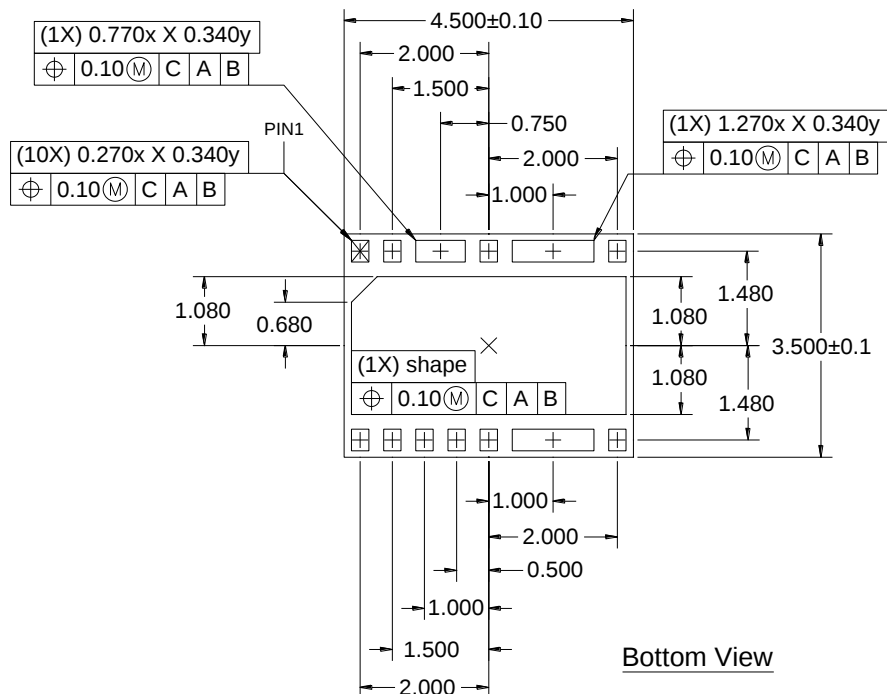
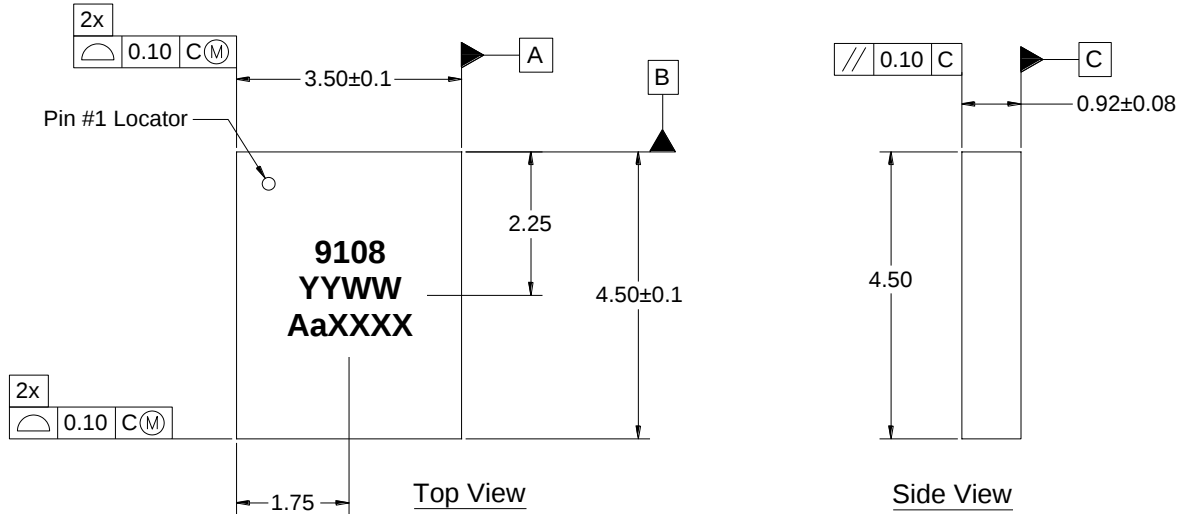


Top View

Pad No.	Label	Description
1	V _{BIAS}	DC voltage supply input for active biasing circuit
2	V _{CC}	DC voltage supply input for Amp1 and Amp 2
3, 4, 5, 6, 8, 9, 10	N/C	No internal connection. Provide grounded land pads for PCB mounting integrity.
7	RF out	RF output pin. Internally DC blocked
11	V _{PD2}	Power down control input for Amp 2. This voltage adjusts for the current draw in Amp 2.
12	V _{PD1}	Power down control input for Amp 1. This voltage adjusts for the current draw in Amp 1.
13	RF in	RF input pin. Internally DC blocked
Backside Pad	GND	RF/DC ground. Use recommended via hole pattern to minimize inductance and thermal resistance; see PCB Mounting Pattern for suggested footprint.

Package Marking and Dimensions

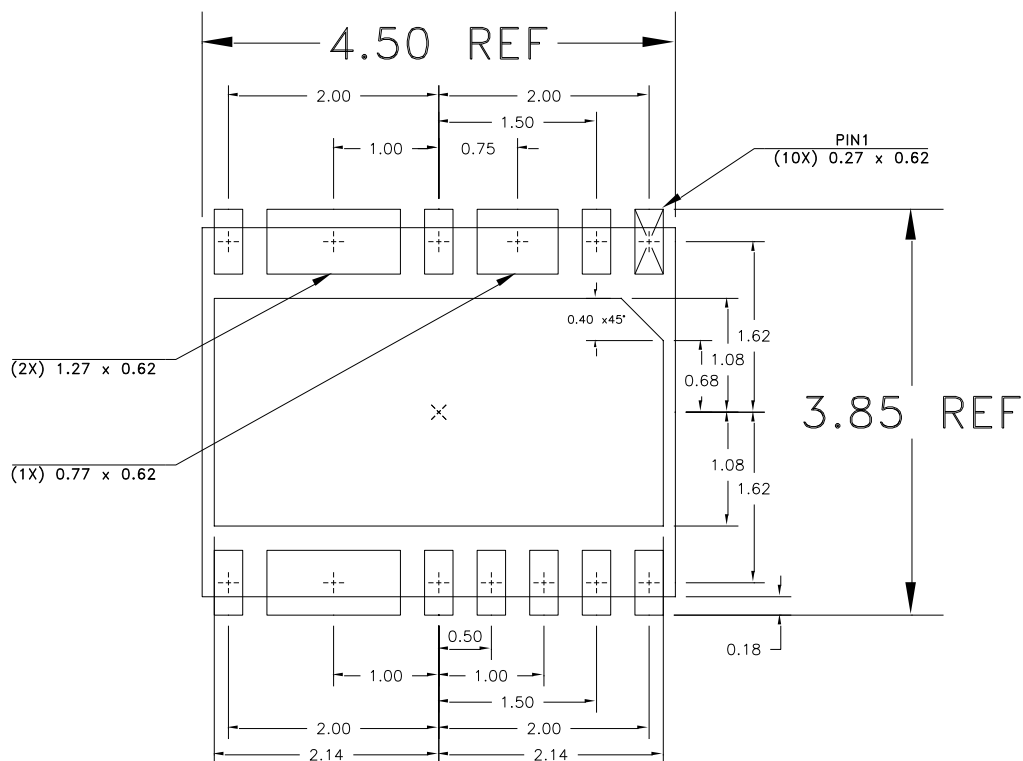
Marking: Part Number – TQP9108
 Date – YYWW
 Lot Code - AaXXXX



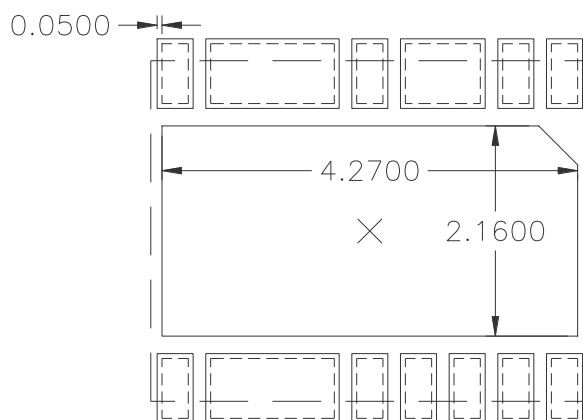
- Notes:
1. All dimensions are in millimeters. Angles are in degrees.
 2. The terminal #1 identifier and terminal numbering conform to JESD 95-1 SPP-012.
 3. Contact plating: Au over Ni

PCB Mounting Pattern

Recommend PCB land-pad pattern metallization (Top View)



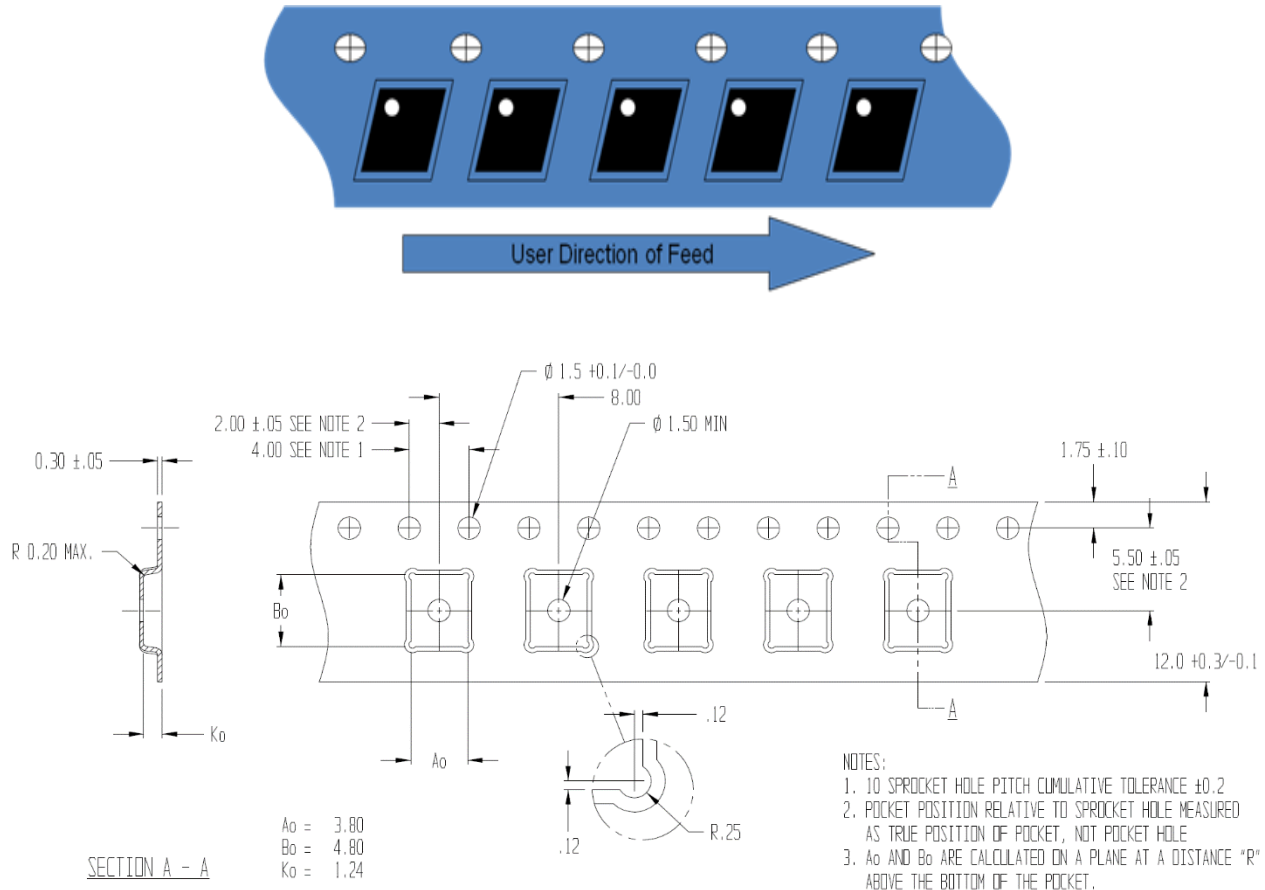
Recommended PCB solder mask opening (Top View)



Notes:

1. A heat sink underneath the area of the PCB for the mounted device is strictly required for proper thermal operation. Damage to the device can occur without the use of one.
2. Ground / thermal via holes are critical for the proper performance of this device. Vias should use a .35mm (#80 / .0135") diameter drill and have a final plated thru diameter of .25 mm (.010").
3. Add as much copper as possible to inner and outer layers near the part to ensure optimal thermal performance.

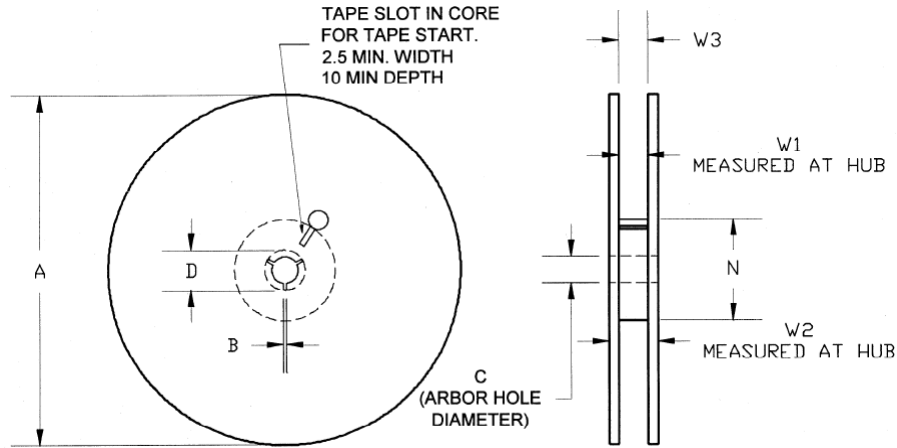
Tape and Reel Information – Carrier and Cover Tape Dimensions



Feature	Measure	Symbol	Size (in)	Size (mm)
Cavity	Length	A0	0.150	3.80
	Width	B0	0.199	4.80
	Depth	K0	0.049	1.24
	Pitch	P1	0.315	8.00
Centerline Distance	Cavity to Perforation - Length Direction	P2	0.079	2.00
	Cavity to Perforation - Width Direction	F	0.217	5.50
Cover Tape	Width	C	0.362	9.20
Carrier Tape	Width	W	0.472	12.00

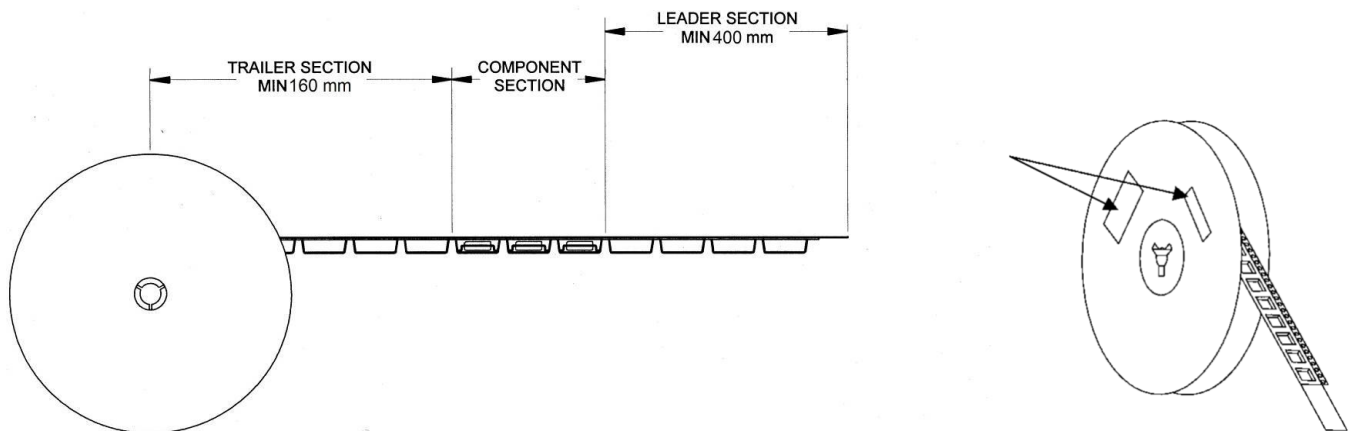
Tape and Reel Information – Reel Dimensions (13")

Standard T/R size = 2,500 pieces on a 13" reel.



Feature	Measure	Symbol	Size (in)	Size (mm)
Flange	Diameter	A	12.992	330.0
	Thickness	W2	0.717	18.2
	Space Between Flange	W1	0.504	12.8
Hub	Outer Diameter	N	4.016	102.0
	Arbor Hole Diameter	C	0.512	13.0
	Key Slit Width	B	0.079	2.0
	Key Slit Diameter	D	0.787	20.0

Tape and Reel Information – Tape Length and Label Placement



Notes:

1. Empty part cavities at the trailing and leading ends are sealed with cover tape. See EIA 481-1-A.
2. Labels are placed on the flange opposite the sprockets in the carrier tape.

Handling Precautions

Parameter	Rating	Standard
ESD – Human Body Model (HBM)	Class 1C	ESDA / JEDEC JS-001-2012
ESD – Charged Device Model (CDM)	Class C3	JEDEC JESD22-C101F
MSL – Moisture Sensitivity Level	Level 3	IPC/JEDEC J-STD-020



Caution!
ESD-Sensitive Device

Solderability

Compatible with both lead-free (260°C max. reflow temp.) and tin/lead (245°C max. reflow temp.) soldering processes.
Solder profiles available upon request.
Contact plating: Electrolytic plated Au over Ni

RoHS Compliance

This part is compliant with 2011/65/EU RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment) as amended by Directive 2015/863/EU.

This product also has the following attributes:

- Lead Free
- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A (C₁₅H₁₂Br₄O₂) Free
- PFOS Free



Contact Information

For the latest specifications, additional product information, worldwide sales and distribution locations:

Web: www.qorvo.com

Tel: 1-844-890-8163

Email: customer.support@qorvo.com

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